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- Output Ports Have Equivalent 25- $\Omega$  Series Resistors, So No External Resistors Are Required
- State-of-the-Art *EPIC-IIB™* BiCMOS Design Significantly Reduces Power Dissipation
- Flow-Through Architecture Optimizes **PCB Layout**
- Latch-Up Performance Exceeds 500 mA Per JEDEC Standard JESD-17
- Typical V<sub>OLP</sub> (Output Ground Bounce) < 1 V at  $V_{CC} = 5 \text{ V}, T_A = 25^{\circ}\text{C}$
- **Package Options Include Plastic** Small-Outline (DW) Package, Ceramic Chip Carriers (FK), and Plastic (NT) and Ceramic (JT) DIPs

### description

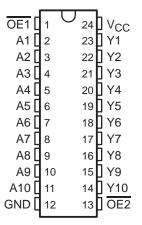
These 10-bit buffers or bus drivers provide a high-performance bus interface for wide data paths or buses carrying parity.

The 3-state control gate is a 2-input AND gate with active-low inputs so that if either output-enable (OE1 or OE2) input is high, all ten outputs are in the high-impedance state. The 'ABT2827 provide true data at their outputs.

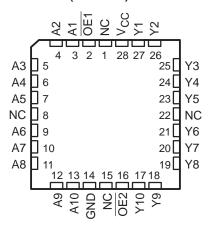
To ensure the high-impedance state during power up or power down,  $\overline{OE}$  should be tied to  $V_{CC}$ through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

The outputs, which are designed to source or sink up to 12 mA, include equivalent 25- $\Omega$  series resistors to reduce overshoot and undershoot.

### SN54ABT2827 . . . JT PACKAGE SN74ABT2827 . . . DW OR NT PACKAGE (TOP VIEW)



#### SN54ABT2827 . . . FK PACKAGE (TOP VIEW)



NC - No internal connection

The SN54ABT2827 is characterized for operation over the full military temperature range of –55°C to 125°C. The SN74ABT2827 is characterized for operation from -40°C to 85°C.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

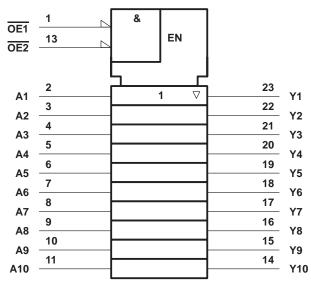
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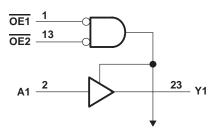
#### **FUNCTION TABLE**

|     | INPUTS | OUTPUT |   |
|-----|--------|--------|---|
| OE1 | OE2    | Α      | Y |
| L   | L      | L      | L |
| L   | L      | Н      | Н |
| Н   | X      | Χ      | Z |
| Х   | Н      | Χ      | Z |

### logic symbol†



### logic diagram (positive logic)



To Nine Other Channels

Pin numbers shown are for the DW, JT, and NT packages.

# absolute maximum ratings over operating free-air temperature range (unless otherwise noted)‡

| Supply voltage range,               | V <sub>CC</sub>  | –0.5 V to 7 V  |
|-------------------------------------|--|----------------|
| Input voltage range, V <sub>I</sub> | (see Note 1)   | 0.5 V to 7 V   |
| Voltage range applied               | to any output in the high or power-off state, $V_{\hbox{\scriptsize O}}$ |                |
| Current into any output             | t in the low state, IO: SN54ABT2827                                      | 96 mA          |
|                                     | SN74ABT2827  | 128 mA         |
| Input clamp current, III            | $\langle (V_1 < 0) \dots \rangle$  | –18 mA         |
| Output clamp current,               | $I_{OK}(V_O < 0)$  |                |
| Package thermal impe                | dance, θ <sub>JA</sub> (see Note 2): DW package                          | 81°C/W         |
| -                                   | -  | 67°C/W         |
| Storage temperature ra              | ange, T <sub>sta</sub>   | –65°C to 150°C |

<sup>‡</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.



<sup>†</sup> This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

NOTES: 1. The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.

<sup>2.</sup> The package thermal impedance is calculated in accordance with EIA/JEDEC Std JESD51, except for through-hole packages, which use a trace length of zero.

### recommended operating conditions (see Note 3)

|       |                                    | SN54AE          | SN54ABT2827 |     | T2827 | UNIT |
|-------|------------------------------------|-----------------|-------------|-----|-------|------|
|       |                                    | MIN             | MAX         | MIN | MAX   | UNIT |
| VCC   | Supply voltage                     | 4.5             | 5.5         | 4.5 | 5.5   | V    |
| VIH   | High-level input voltage           | 2               | EN          | 2   |       | V    |
| VIL   | Low-level input voltage            |                 | 0.8         |     | 0.8   | V    |
| VI    | Input voltage                      | 0<              | Vcc         | 0   | VCC   | V    |
| IOH   | High-level output current          | (ر)             | -12         |     | -12   | mA   |
| loL   | Low-level output current           | $g_{Q_{\zeta}}$ | 12          |     | 12    | mA   |
| Δt/Δν | Input transition rise or fall rate | ) <sub>V</sub>  | 5           |     | 5     | ns/V |
| TA    | Operating free-air temperature     | -55             | 125         | -40 | 85    | °C   |

NOTE 3: Unused inputs must be held high or low to prevent them from floating.

# electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| DADAMETED        | TEST COND                                       | TIONS                            | 1   | T <sub>A</sub> = 25°0 |       | SN54AB | T2827       | SN74AB | UNIT  |      |
|------------------|---|----------------------------------|-----|-----------------------|-------|--------|-------------|--------|-------|------|
| PARAMETER        | TEST COND                                       | IIIONS                           | MIN | TYP <sup>†</sup>      | MAX   | MIN    | MAX         | MIN    | MAX   | UNII |
| VIK              | V <sub>CC</sub> = 4.5 V,                        | I <sub>I</sub> = -18 mA          |     |                       | -1.2  |        | -1.2        |        | -1.2  | V    |
|                  | V <sub>CC</sub> = 4.5 V,                        | I <sub>OH</sub> = -1 mA          | 2.5 |                       |       | 2.5    |             | 2.5    |       |      |
| Vali             | V <sub>CC</sub> = 5 V,                          | I <sub>OH</sub> = -1 mA          | 3   |                       |       | 3      |             | 3      |       | V    |
| Voн              | V <sub>CC</sub> = 4.5 V                         | $I_{OH} = -3 \text{ mA}$         | 2.4 |                       |       | 2.4    |             | 2.4    |       | V    |
|                  | VCC = 4.5 V                                     | $I_{OH} = -12 \text{ mA}$        | 2   |                       |       | 2      |             | 2      |       |      |
| VoL              | V <sub>CC</sub> = 4.5 V                         | I <sub>OL</sub> = 12 mA          |     |                       | 0.8   |        | 0.8         |        | 0.8   | V    |
| V <sub>hys</sub> |   |                                  |     | 100                   |       |        |             |        |       | mV   |
| ΙĮ               | $V_{CC} = 0 \text{ to } 5.5 \text{ V},$         | $V_I = V_{CC}$ or GND            |     |                       | ±1    |        | #1          |        | ±1    | μΑ   |
| lozh             | V <sub>CC</sub> = 5.5 V,                        | V <sub>O</sub> = 2.7 V           |     |                       | 10‡   |        | 10          |        | 10‡   | μΑ   |
| lozL             | $V_{CC} = 5.5 V$ ,                              | $V_0 = 0.5 V$                    |     |                       | -10‡  |        | <b>–</b> 10 |        | -10‡  | μΑ   |
| l <sub>off</sub> | $V_{CC} = 0$ ,                                  | $V_I$ or $V_O \le 4.5 \text{ V}$ |     |                       | ±100  |        | . 6         |        | ±100  | μΑ   |
| ICEX             | V <sub>CC</sub> = 5.5 V, V <sub>O</sub> = 5.5 V | Outputs high                     |     |                       | 50    | 3      | 50          |        | 50    | μΑ   |
| ΙΟ <sup>§</sup>  | V <sub>CC</sub> = 5.5 V,                        | V <sub>O</sub> = 2.5 V           | -50 | -140                  | -225‡ | -50    | -225‡       | -50    | -225‡ | mA   |
|                  | V <sub>CC</sub> = 5.5 V,                        | Outputs high                     |     | 80                    | 250   | Q      | 250         |        | 250   | μΑ   |
| lcc              | $I_{O} = 0$ ,                                   | Outputs low                      |     | 35                    | 40‡   |        | 40‡         |        | 40‡   | mA   |
|                  | $V_I = V_{CC}$ or GND                           | Outputs disabled                 |     | 80                    | 250   |        | 250         |        | 250   | μΑ   |
|                  | V <sub>CC</sub> = 5.5 V,                        | Outputs enabled                  |     |                       | 1.5   |        | 1.5         |        | 1.5   | mA   |
| Δlcc¶            | One input at 3.4 V, Other inputs at             | Outputs disabled                 |     |                       | 50    |        | 50          |        | 50    | μΑ   |
|                  | V <sub>CC</sub> or GND                          | Control inputs                   |     |                       | 1.5   |        | 1.5         |        | 1.5   | mA   |
| C <sub>i</sub>   | V <sub>I</sub> = 2.5 V or 0.5 V                 |                                  |     | 4                     |       |        |             |        |       | pF   |
| Co               | V <sub>O</sub> = 2.5 V or 0.5 V                 |                                  |     | 8.5                   |       |        |             |        |       | pF   |

 $<sup>^{\</sup>dagger}$  All typical values are at V<sub>CC</sub> = 5 V, T<sub>A</sub> = 25°C.



<sup>‡</sup> This data sheet limit may vary among suppliers.

<sup>§</sup> Not more than one output should be tested at a time, and the duration of the test should not exceed one second.

<sup>¶</sup> This is the increase in supply current for each input that is at the specified TTL voltage level rather than V<sub>CC</sub> or GND.

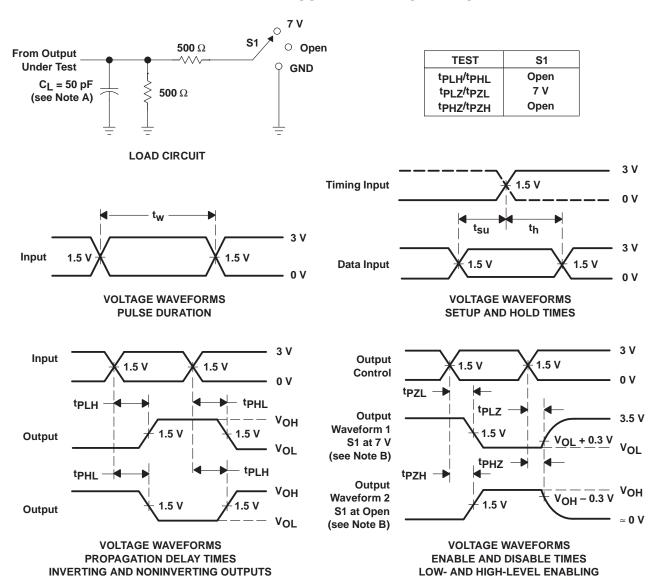
# SN54ABT2827, SN74ABT2827 10-BIT BUFFERS/DRIVERS WITH 3-STATE OUTPUTS

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switching characteristics over recommended ranges of supply voltage and operating free-air temperature,  $C_L = 50 \text{ pF}$  (unless otherwise noted) (see Figure 1)

| PARAMETER        | FROM<br>(INPUT) | TO<br>(OUTPUT) | V <sub>CC</sub> = 5 V,<br>T <sub>A</sub> = 25°C |     |     | SN54AB | T2827 | SN74ABT2827 |     | UNIT |
|------------------|-----------------|----------------|---|-----|-----|--------|-------|-------------|-----|------|
|                  | (INFOT)         | (001101)       | MIN   | TYP | MAX | MIN    | MAX   | MIN         | MAX |      |
| <sup>t</sup> PLH | А               | V              | 1.1   | 3.3 | 5.1 | 1.1    | 5.6   | 1.1         | 5.5 |      |
| <sup>t</sup> PHL |                 | Ť              | 1.1   | 2.7 | 4.5 | 1.1    | 5.2   | 1.1         | 5.1 | ns   |
| <sup>t</sup> PZH | ŌĒ              | Υ              | 1   | 4   | 5.9 | 1      | 6.8   | 1           | 6.7 |      |
| <sup>t</sup> PZL |                 |                | 1   | 4.2 | 6.8 | 39     | 8     | 1           | 7.8 | ns   |
| <sup>t</sup> PHZ | ŌĒ              | Y              | 2   | 5.3 | 6.7 | 0 2    | 7.4   | 2           | 7.2 |      |
| t <sub>PLZ</sub> |                 |                | 1.3   | 4.8 | 7.2 | 1.3    | 8.5   | 1.3         | 7.5 | ns   |

### PARAMETER MEASUREMENT INFORMATION



NOTES: A. C<sub>I</sub> includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  10 MHz,  $Z_O$  = 50  $\Omega$ ,  $t_f \leq$  2.5 ns,  $t_f \leq$  2.5 n
- D. The outputs are measured one at a time with one transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms



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### PACKAGING INFORMATION

| Orderable part number | Status | Material type | Package   Pins | Package qty   Carrier | RoHS | Lead finish/  | MSL rating/        | Op temp (°C) | Part marking |
|-----------------------|--------|---------------|----------------|-----------------------|------|---------------|--------------------|--------------|--------------|
|                       | (1)    | (2)           |                |                       | (3)  | Ball material | Peak reflow        |              | (6)          |
|                       |        |               |                |                       |      | (4)           | (5)                |              |              |
| SN74ABT2827DW         | Active | Production    | SOIC (DW)   24 | 25   TUBE             | Yes  | NIPDAU        | Level-1-260C-UNLIM | -40 to 85    | ABT2827      |
| SN74ABT2827DW.B       | Active | Production    | SOIC (DW)   24 | 25   TUBE             | Yes  | NIPDAU        | Level-1-260C-UNLIM | -40 to 85    | ABT2827      |
| SN74ABT2827DWR        | Active | Production    | SOIC (DW)   24 | 2000   LARGE T&R      | Yes  | NIPDAU        | Level-1-260C-UNLIM | -40 to 85    | ABT2827      |
| SN74ABT2827DWR.B      | Active | Production    | SOIC (DW)   24 | 2000   LARGE T&R      | Yes  | NIPDAU        | Level-1-260C-UNLIM | -40 to 85    | ABT2827      |

<sup>(1)</sup> Status: For more details on status, see our product life cycle.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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<sup>(3)</sup> RoHS values: Yes, No, RoHS Exempt. See the TI RoHS Statement for additional information and value definition.

<sup>(4)</sup> Lead finish/Ball material: Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

<sup>(5)</sup> MSL rating/Peak reflow: The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

<sup>(6)</sup> Part marking: There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

# **PACKAGE MATERIALS INFORMATION**

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### TAPE AND REEL INFORMATION





| A0 | Dimension designed to accommodate the component width     |
|----|---|
| В0 | Dimension designed to accommodate the component length    |
| K0 | Dimension designed to accommodate the component thickness |
| W  | Overall width of the carrier tape                         |
| P1 | Pitch between successive cavity centers                   |

### QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



#### \*All dimensions are nominal

| Device         |      | Package<br>Drawing |    | SPQ  | Reel<br>Diameter<br>(mm) | Reel<br>Width<br>W1 (mm) | A0<br>(mm) | B0<br>(mm) | K0<br>(mm) | P1<br>(mm) | W<br>(mm) | Pin1<br>Quadrant |
|----------------|------|--------------------|----|------|--------------------------|--------------------------|------------|------------|------------|------------|-----------|------------------|
| SN74ABT2827DWR | SOIC | DW                 | 24 | 2000 | 330.0                    | 24.4                     | 10.75      | 15.7       | 2.7        | 12.0       | 24.0      | Q1               |

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### \*All dimensions are nominal

| ſ | Device         | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|---|----------------|--------------|-----------------|------|------|-------------|------------|-------------|
| I | SN74ABT2827DWR | SOIC         | DW              | 24   | 2000 | 350.0       | 350.0      | 43.0        |

# **PACKAGE MATERIALS INFORMATION**

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### **TUBE**



### \*All dimensions are nominal

| Device          | Package Name | Package Type | Pins | SPQ | L (mm) | W (mm) | T (µm) | B (mm) |
|-----------------|--------------|--------------|------|-----|--------|--------|--------|--------|
| SN74ABT2827DW   | DW           | SOIC         | 24   | 25  | 506.98 | 12.7   | 4826   | 6.6    |
| SN74ABT2827DW.B | DW           | SOIC         | 24   | 25  | 506.98 | 12.7   | 4826   | 6.6    |

DW (R-PDSO-G24)

# PLASTIC SMALL OUTLINE



NOTES: A. All linear dimensions are in inches (millimeters). Dimensioning and tolerancing per ASME Y14.5M-1994.

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
- D. Falls within JEDEC MS-013 variation AD.



DW (R-PDSO-G24)

PLASTIC SMALL OUTLINE



NOTES:

- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Refer to IPC7351 for alternate board design.
- D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525
- E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.



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